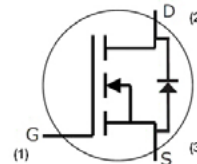


C3M0015065D

Silicon Carbide Power MOSFET
C3M™ MOSFET Technology
N-Channel Enhancement Mode



TO-247-3



Package Types: TO-247-3
PN's: C3M0015065D

Features

- 3rd generation SiC MOSFET technology
- High blocking voltage with low on-resistance
- High speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant

Wolfspeed, Inc. is in the process of rebranding its products and related materials pursuant to the entity name change from Cree, Inc. to Wolfspeed, Inc. During this transition period, products received may be marked with either the Cree name and/or logo or the Wolfspeed name and/or logo.

Typical Applications

- EV charging
- Solar PV inverters
- UPS
- SMPS
- DC/DC converters

Benefits

- Higher system efficiency
- Reduced cooling requirements
- Increased power density
- Increased system switching frequency
- Easy to parallel and simple to drive
- Enable new hard switching PFC topologies (Totem-Pole)

Key Parameters

Parameter	Symbol	Min.	Typ.	Max	Unit	Conditions	Note
Drain - Source Voltage	V_{DS}			650	V	$T_c = 25^\circ\text{C}$	
Maximum Gate - Source Voltage	$V_{GS(max)}$	-8		+19		Transient	
Operational Gate-Source Voltage	$V_{GS op}$		-4/15			Static	Note 1
DC Continuous Drain Current	I_D			120	A	$V_{GS} = 15\text{ V}, T_c = 25^\circ\text{C}, T_J \leq 175^\circ\text{C}$	Fig. 19 Note 2
				96		$V_{GS} = 15\text{ V}, T_c = 100^\circ\text{C}, T_J \leq 175^\circ\text{C}$	
Pulsed Drain Current	I_{DM}			418		t_{Pmax} limited by T_{Jmax} $V_{GS} = 15\text{ V}, T_c = 25^\circ\text{C}$	Fig. 22
Power Dissipation	P_D			416	W	$T_c = 25^\circ\text{C}, T_J = 175^\circ\text{C}$	Fig. 20
Operating Junction and Storage Temperature	T_J, T_{stg}			-40 to +175	$^\circ\text{C}$		
Solder Temperature	T_L			260		According to JEDEC J-STD-020	
Mounting Torque	M_D			1 8.8	Nm lbf-in	M3 or 6-32 screw	

Note (1): Recommended turn-on gate voltage is 15V with $\pm 5\%$ regulation tolerance, see Application Note PRD-04814 for additional details

Note (2): Verified by design


Electrical Characteristics ($T_C = 25^\circ\text{C}$ Unless Otherwise Specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions	Note
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	650				$V_{GS} = 0\text{ V}, I_D = 100\text{ }\mu\text{A}$	
Gate Threshold Voltage	$V_{GS(th)}$	1.8	2.3	3.6	V	$V_{DS} = V_{GS}, I_D = 15.5\text{ mA}$	Fig. 11
			1.9			$V_{DS} = V_{GS}, I_D = 15.5\text{ mA}, T_J = 175^\circ\text{C}$	
Zero Gate Voltage Drain Current	I_{DSS}		1	50	μA	$V_{DS} = 650\text{ V}, V_{GS} = 0\text{ V}$	
Gate-Source Leakage Current	I_{GSS}		10	250	nA	$V_{GS} = 15\text{ V}, V_{DS} = 0\text{ V}$	
Drain-Source On-State Resistance	$R_{DS(on)}$	10.5	15	21	m Ω	$V_{GS} = 15\text{ V}, I_D = 55.8\text{ A}$	Fig. 4,5,6
			20			$V_{GS} = 15\text{ V}, I_D = 55.8\text{ A}, T_J = 175^\circ\text{C}$	
Transconductance	g_{fs}		42		S	$V_{DS} = 20\text{ V}, I_{DS} = 55.8\text{ A}$	Fig. 7
			40			$V_{DS} = 20\text{ V}, I_{DS} = 55.8\text{ A}, T_J = 175^\circ\text{C}$	
Input Capacitance	C_{iss}		5011		pF	$V_{GS} = 0\text{ V}, V_{DS} = 400\text{ V}$ $f = 100\text{ kHz}$ $V_{AC} = 25\text{ mV}$	Fig. 17,18
Output Capacitance	C_{oss}		289				
Reverse Transfer Capacitance	C_{rss}		31				Note 3
Effective Output Capacitance (Energy Related)	$C_{o(er)}$		357				
Effective Output Capacitance (Time Related)	$C_{o(tr)}$		516				
C_{oss} Stored Energy	E_{oss}		29		μJ		Fig. 16
Turn-On Switching Energy (Body Diode)	E_{ON}		1500		μJ	$V_{DS} = 400\text{ V}, V_{GS} = -4\text{ V}/15\text{ V}, I_D = 55.8\text{ A},$ $R_{G(ext)} = 5\text{ }\Omega, L = 57.6\text{ }\mu\text{H}, T_J = 175^\circ\text{C}$ FWD = Internal Body Diode of MOSFET	Fig. 25
Turn Off Switching Energy (Body Diode)	E_{OFF}		700				
Turn-On Switching Energy (External Diode)	E_{ON}		1200		μJ	$V_{DS} = 400\text{ V}, V_{GS} = -4\text{ V}/15\text{ V}, I_D = 55.8\text{ A},$ $R_{G(ext)} = 5\text{ }\Omega, L = 57.6\text{ }\mu\text{H}, T_J = 175^\circ\text{C}$ FWD = External SiC DIODE	Fig. 25
Turn Off Switching Energy (External Diode)	E_{OFF}		1000				
Turn-On Delay Time	$t_{d(on)}$		22		ns	$V_{DD} = 400\text{ V}, V_{GS} = -4\text{ V}/15\text{ V}$ $I_D = 55.8\text{ A}, R_{G(ext)} = 5\text{ }\Omega, L = 57.6\text{ }\mu\text{H}$ Timing Relative to V_{DS} Inductive Load	Fig. 26
Rise Time	t_r		125				
Turn-Off Delay Time	$t_{d(off)}$		58				
Fall Time	t_f		25				
Internal Gate Resistance	$R_{G(int)}$		1.5		Ω	$f = 1\text{ MHz}, V_{AC} = 25\text{ mV}$	
Gate to Source Charge	Q_{gs}		54		nC	$V_{DS} = 400\text{ V}, V_{GS} = -4\text{ V}/15\text{ V}$ $I_D = 55.8\text{ A}$ Per IEC60747-8-4 pg 21	Fig. 12
Gate to Drain Charge	Q_{gd}		62				
Total Gate Charge	Q_g		188				

Note (3): $C_{o(er)}$, a lumped capacitance that gives same stored energy as c_{oss} while V_{DS} is rising from 0 to 400 V.

$C_{o(tr)}$, a lumped capacitance that gives same charging time as c_{oss} while V_{DS} is rising from 0 to 400 V.

Reverse Diode Characteristics

Parameter	Symbol	Typ.	Max.	Unit	Test Conditions	Note
Diode Forward Voltage	V _{SD}	4.7		V	V _{GS} = -4 V, I _{SD} = 27.9 A, T _J = 25 °C	Fig. 8, 9, 10
		4.2			V _{GS} = -4 V, I _{SD} = 27.9 A, T _J = 175 °C	
Continuous Diode Forward Current	I _S		79	A	V _{GS} = -4 V, T _C = 25 °C	
Diode Pulse Current	I _{SM}		418		V _{GS} = -4 V, Pulse Width t _p Limited by T _{Jmax}	
Reverse Recovery Time	t _{rr}	85		ns	V _{GS} = -4 V, I _{SD} = 55.8 A, V _R = 400 V dif/dt = 1500 A/μs, T _J = 175 °C	
Reverse Recovery Charge	Q _{rr}	667		nC		
Peak Reverse Recovery Current	I _{rrm}	17		A		
Reverse Recovery Time	t _{rr}	74		ns	V _{GS} = -4 V, I _{SD} = 55.8 A, V _R = 400 V dif/dt = 1000 A/μs, T _J = 175 °C	
Reverse Recovery Charge	Q _{rr}	562		nC		
Peak Reverse Recovery Current	I _{rrm}	14		A		

Thermal Characteristics

Parameter	Symbol	Typ.	Unit	Test Conditions	Note
Thermal Resistance from Junction to Case	R _{θJC}	0.35	°C/W		Fig. 21
Thermal Resistance from Junction to Ambient	R _{θJA}	40			

Typical Performance

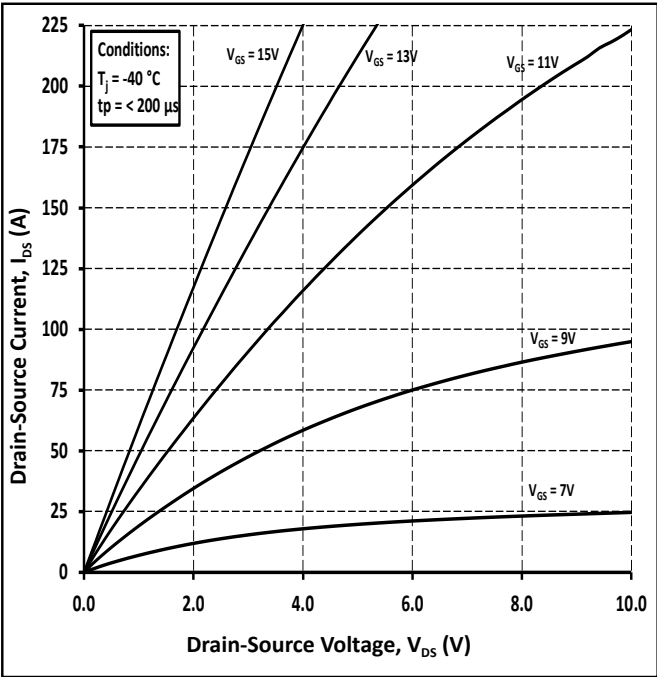


Figure 1. Output Characteristics $T_j = -40\text{ }^{\circ}\text{C}$

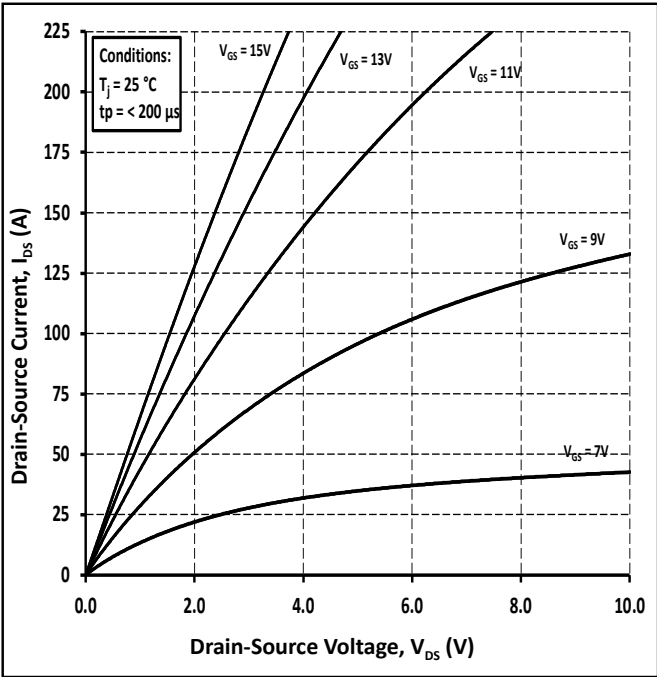


Figure 2. Output Characteristics $T_j = 25\text{ }^{\circ}\text{C}$

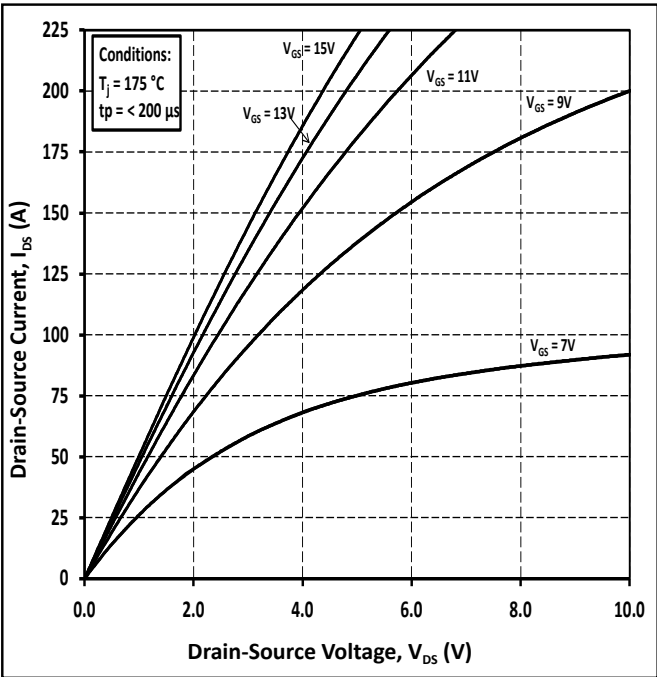


Figure 3. Output Characteristics $T_j = 175\text{ }^{\circ}\text{C}$

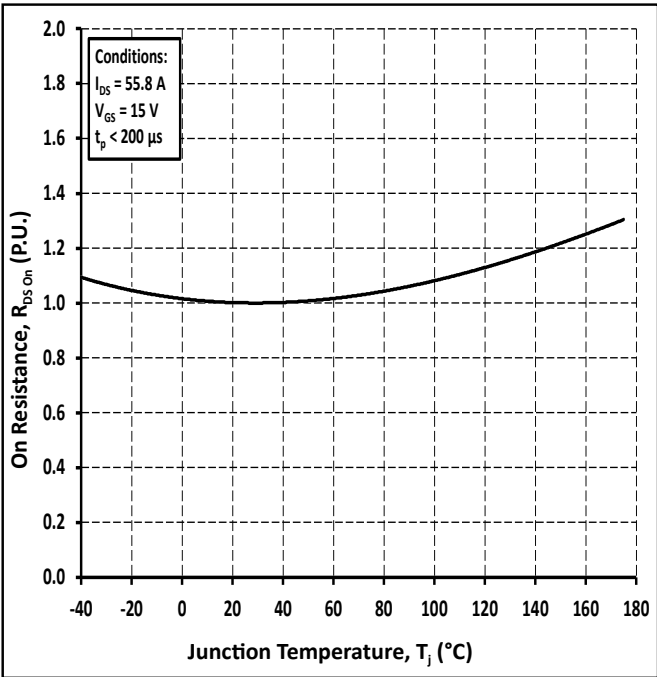


Figure 4. Normalized On-Resistance vs Temperature

Typical Performance

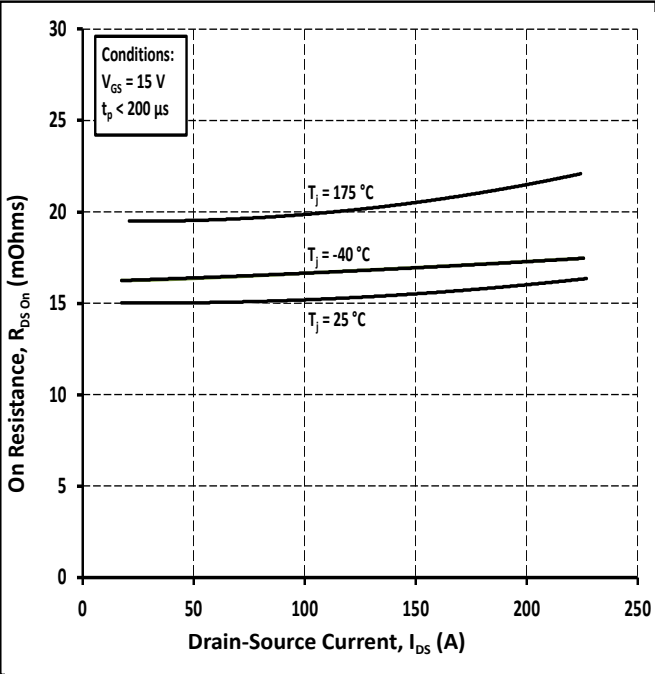


Figure 5. On-Resistance vs Drain Current for Various Temperatures

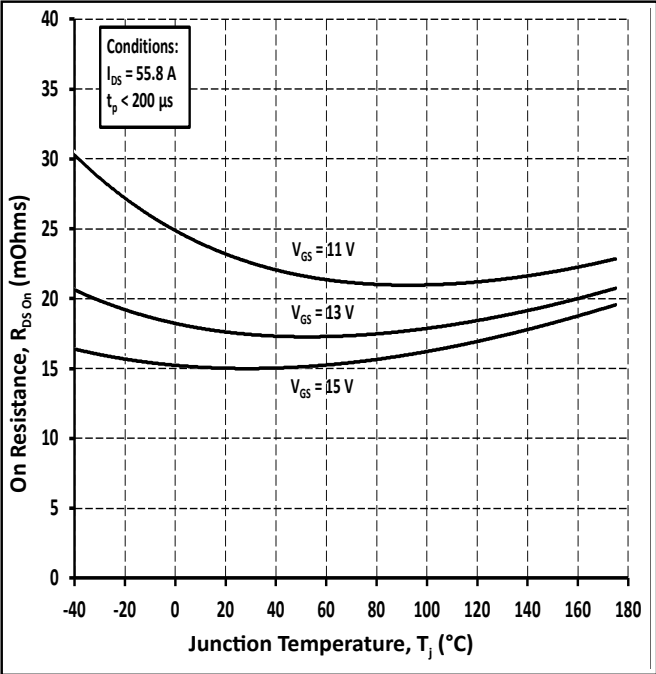


Figure 6. On-Resistance vs Temperature for Various Gate Voltage

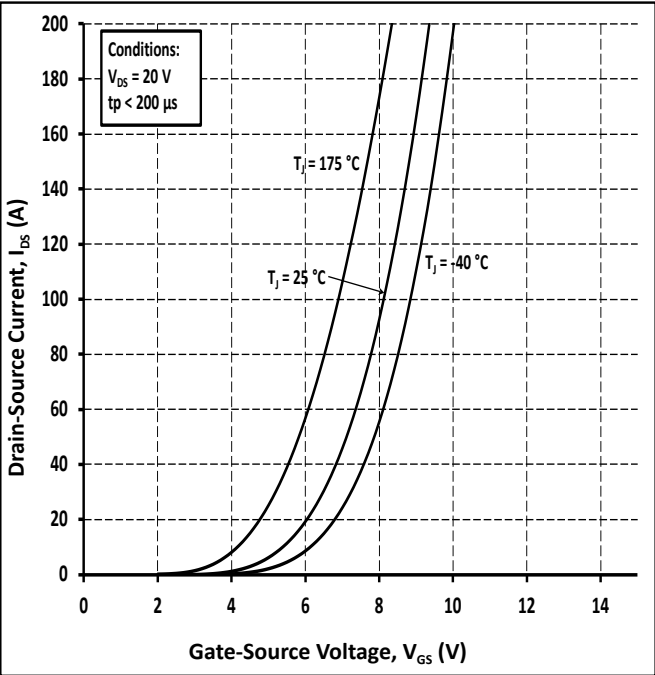


Figure 7. Transfer Characteristic for Various Junction Temperatures

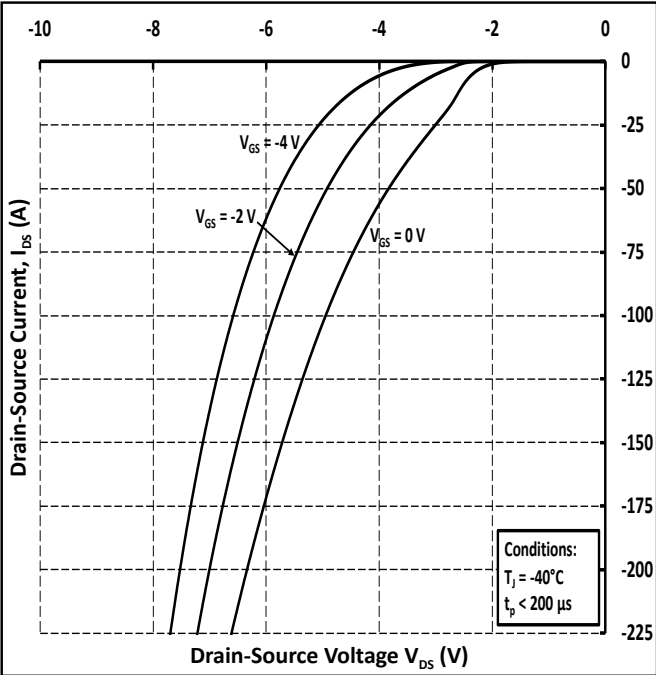


Figure 8. Body Diode Characteristic at -40 °C



Typical Performance

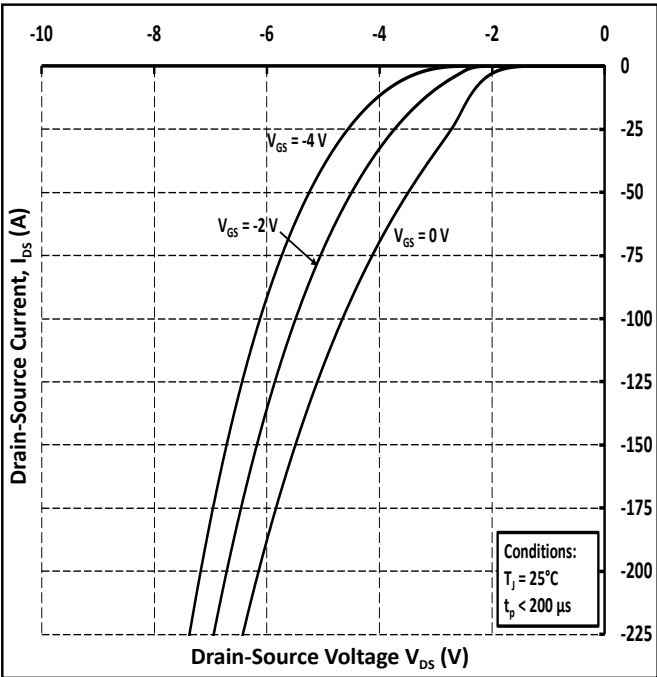


Figure 9. Body Diode Characteristic at 25 °C

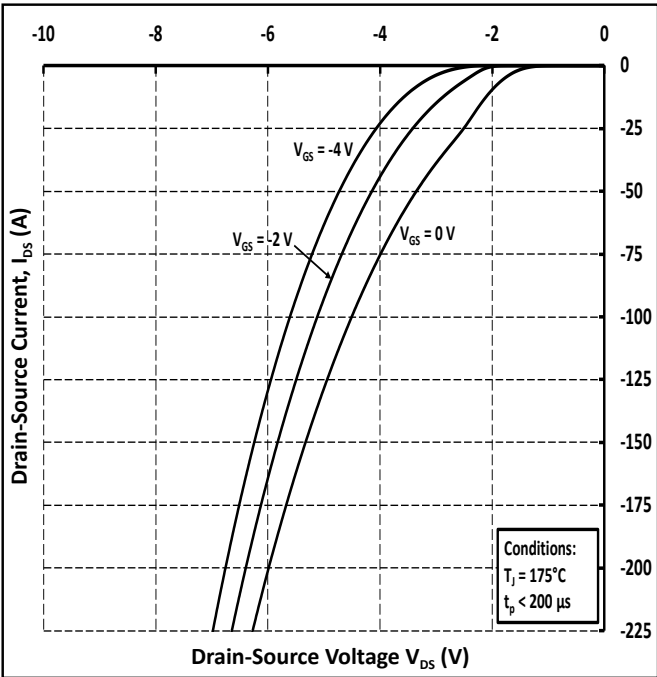


Figure 10. Body Diode Characteristic at 175 °C

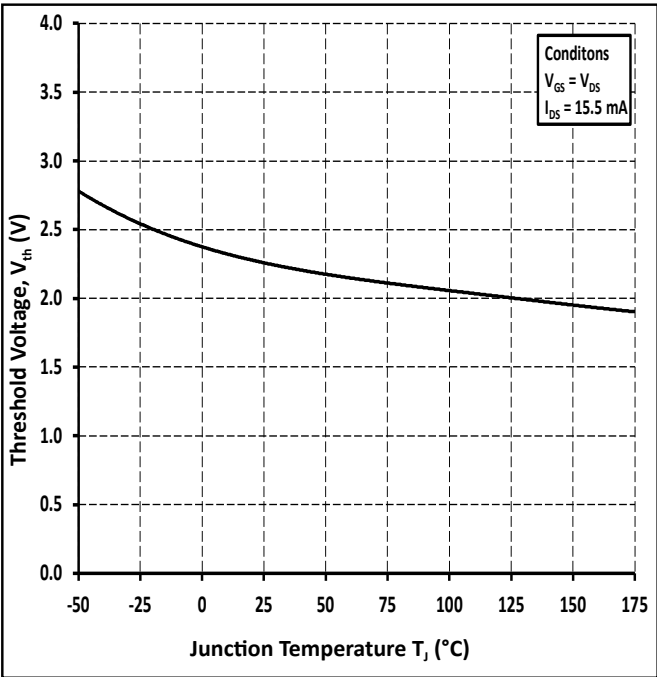


Figure 11. Threshold Voltage vs Temperature

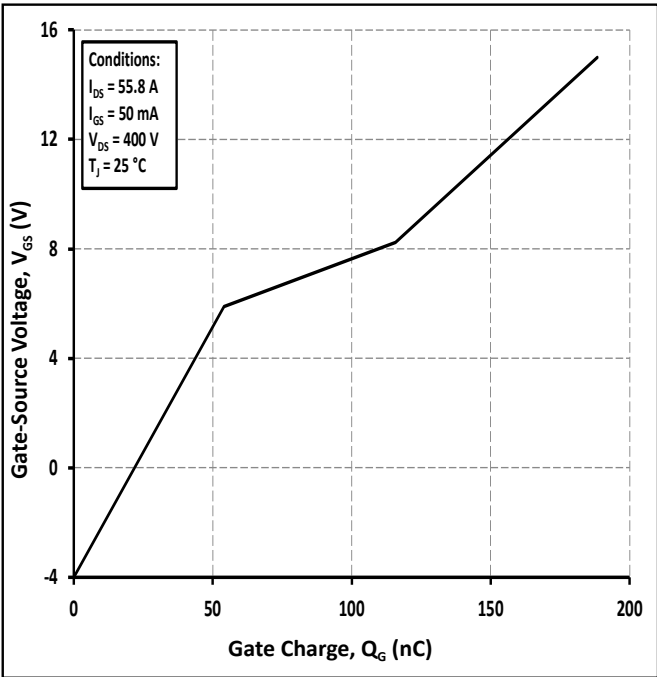


Figure 12. Gate Charge Characteristic

Typical Performance

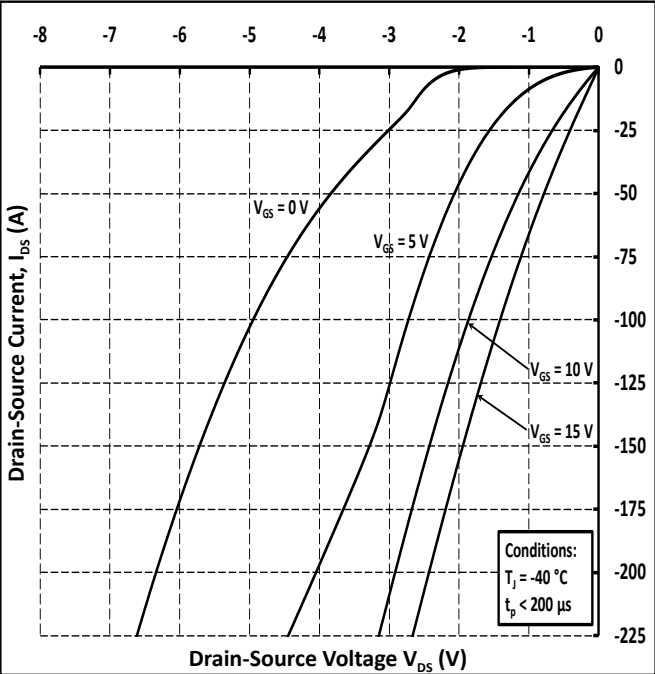


Figure 13. 3rd Quadrant Characteristic at $-40\text{ }^{\circ}\text{C}$

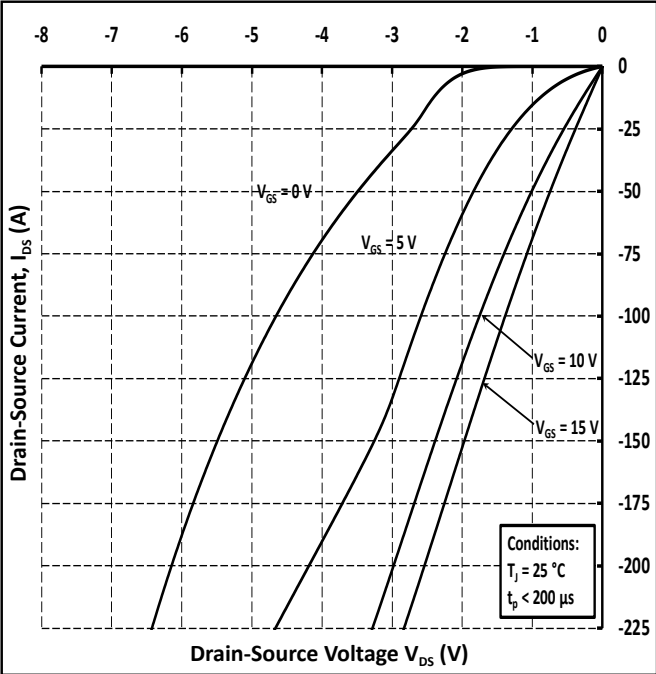


Figure 14. 3rd Quadrant Characteristic at $25\text{ }^{\circ}\text{C}$

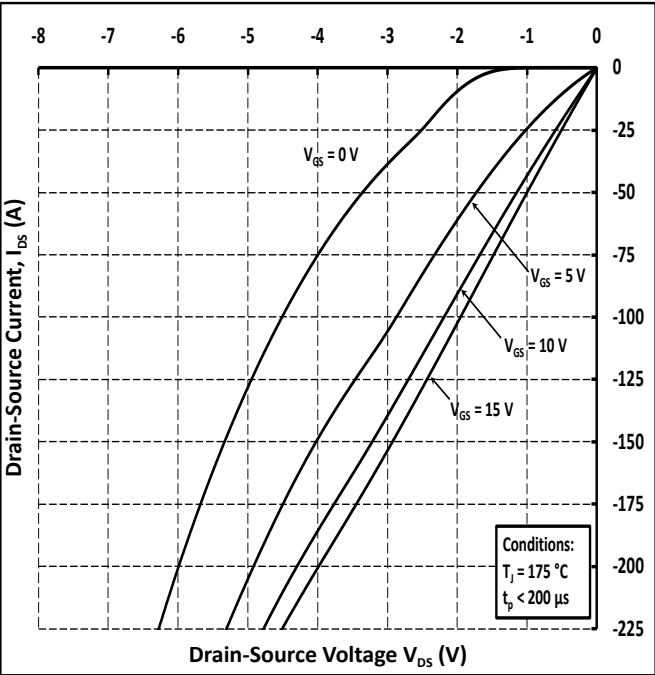


Figure 15. 3rd Quadrant Characteristic at $175\text{ }^{\circ}\text{C}$

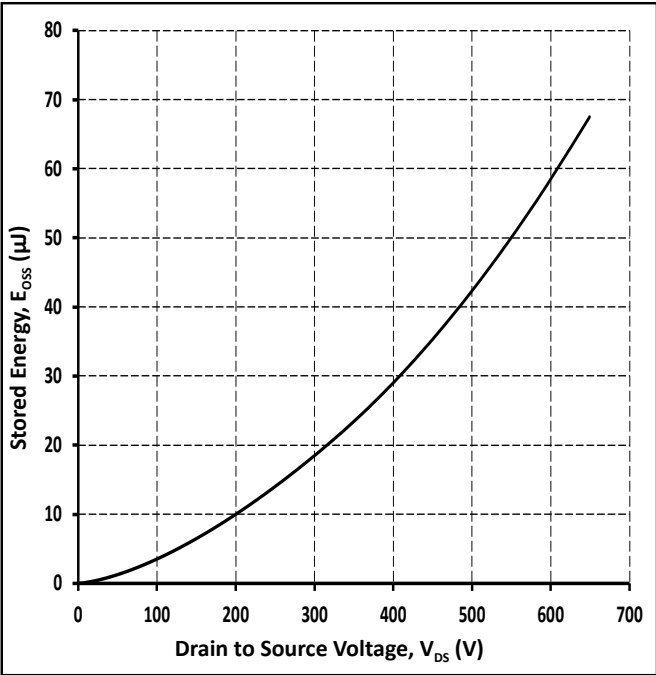


Figure 16. Output Capacitor Stored Energy

Typical Performance

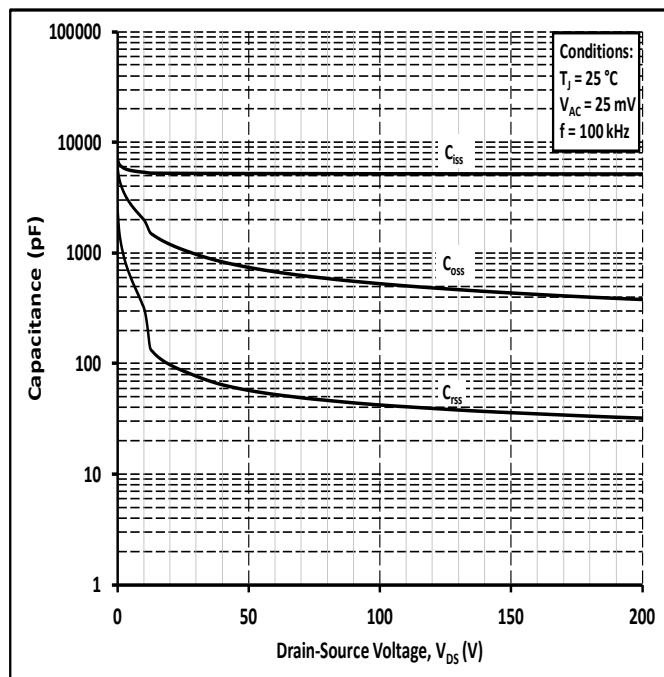


Figure 17. Capacitances vs Drain-Source Voltage (0-200 V)

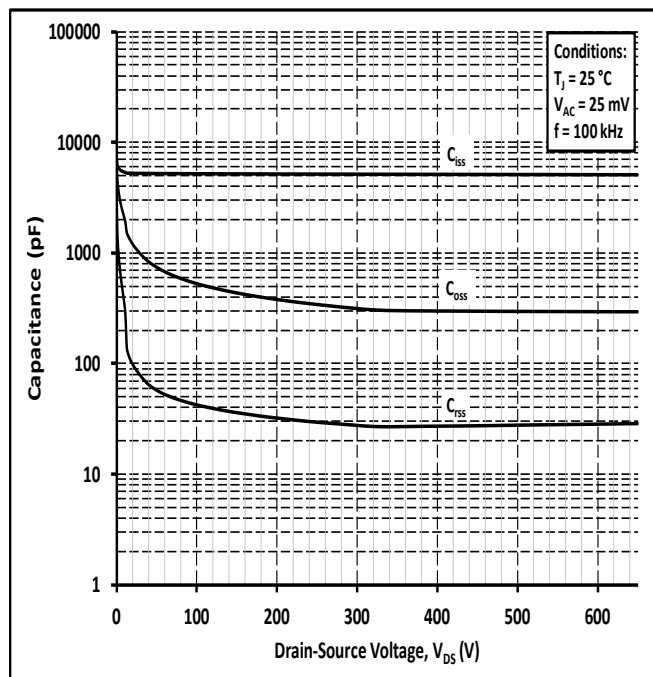


Figure 18. Capacitances vs Drain-Source Voltage (0-650 V)

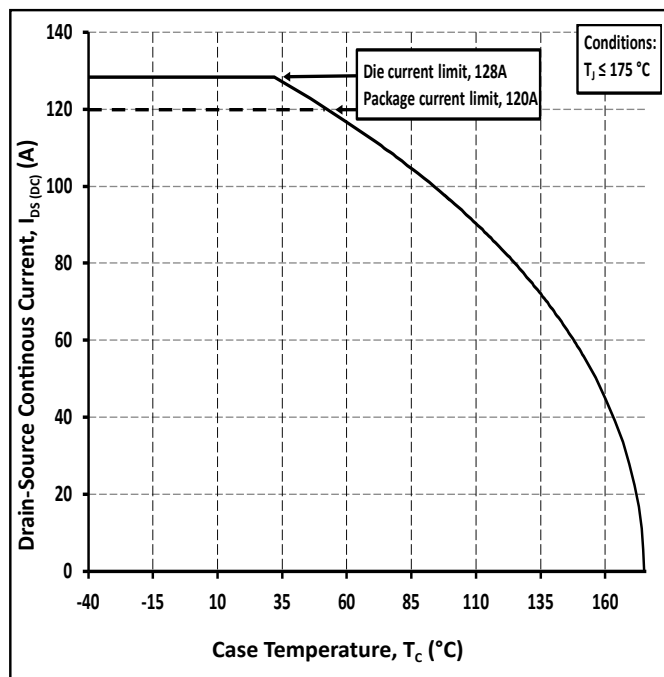


Figure 19. Continuous Drain Current Derating vs Case Temperature

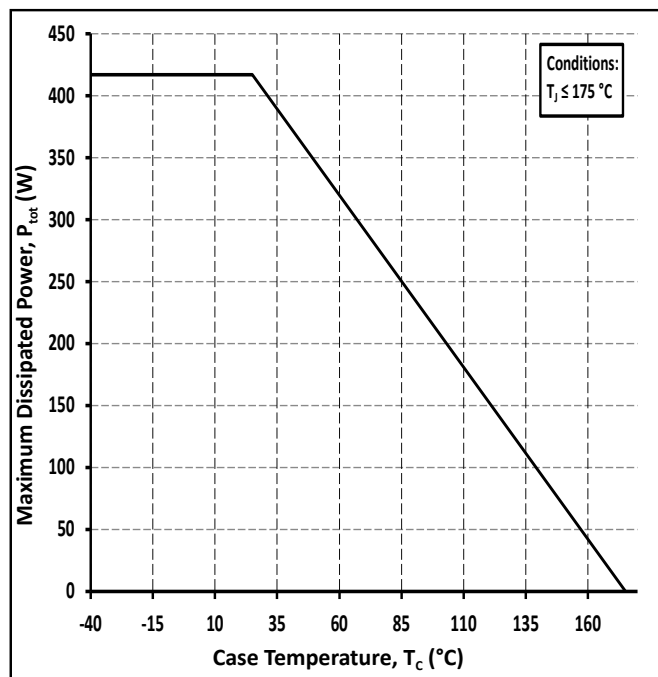


Figure 20. Maximum Power Dissipation Derating vs Case Temperature

Typical Performance

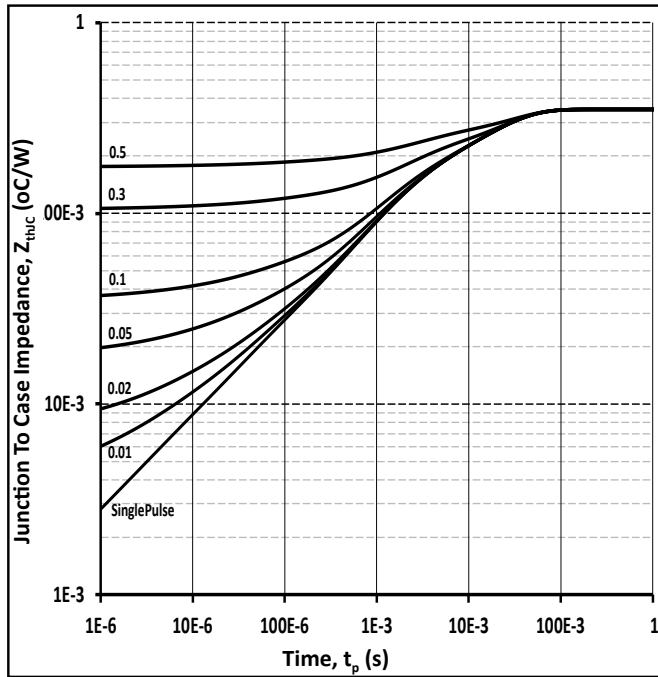


Figure 21. Transient Thermal Impedance (Junction - Case)

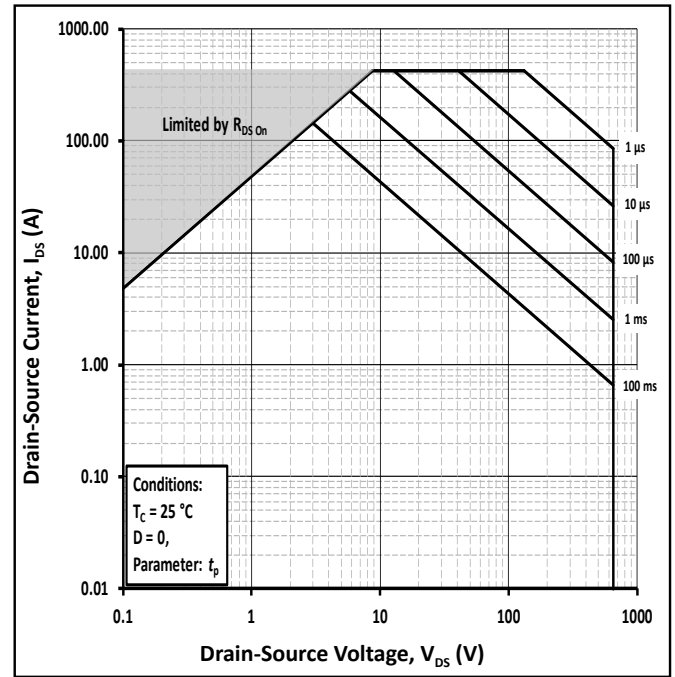


Figure 22. Safe Operating Area

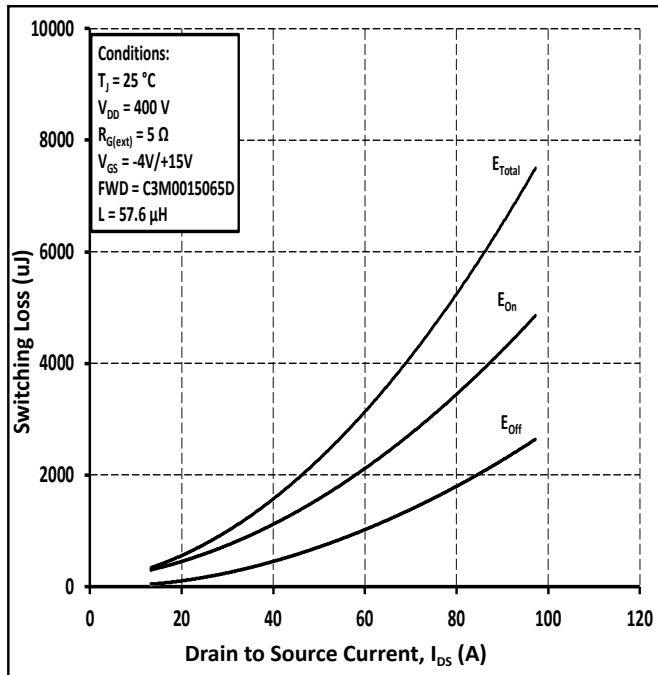


Figure 23. Clamped Inductive Switching Energy vs Drain Current ($V_{DD} = 400\text{ V}$)

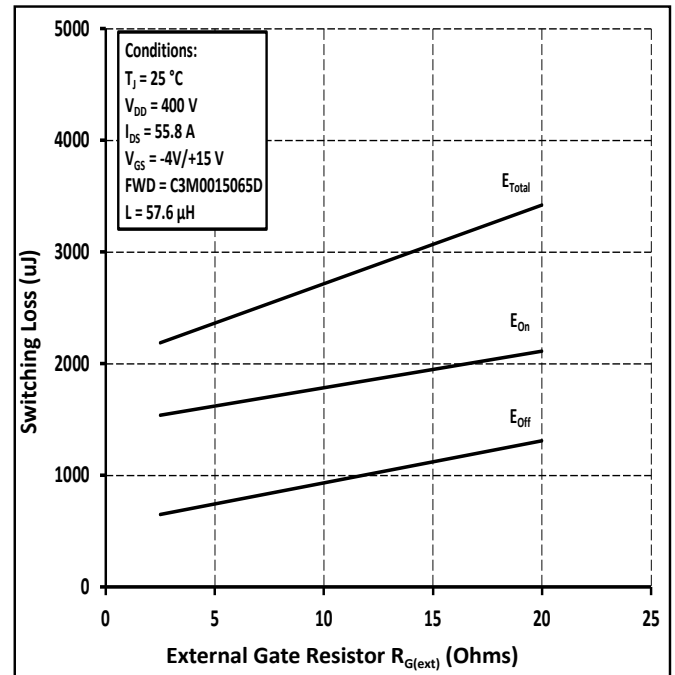


Figure 24. Clamped Inductive Switching Energy vs $R_{G(ext)}$



Typical Performance

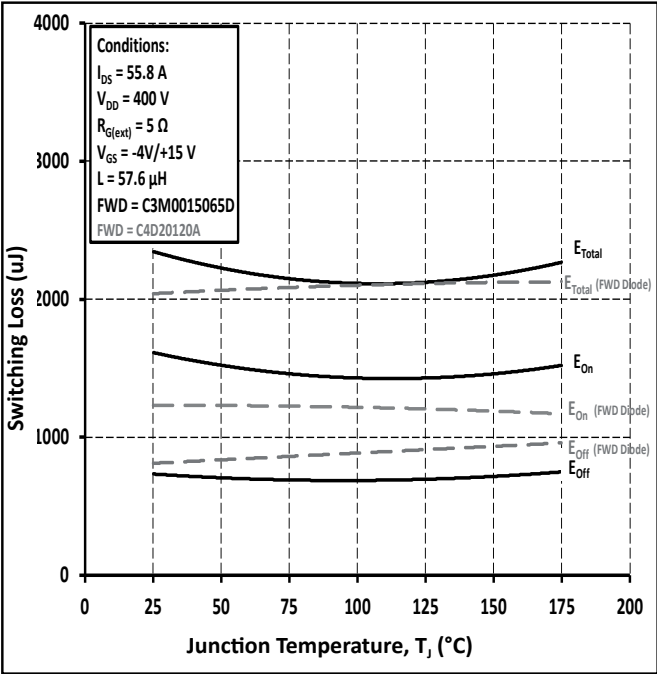


Figure 25. Clamped Inductive Switching Energy vs Temperature

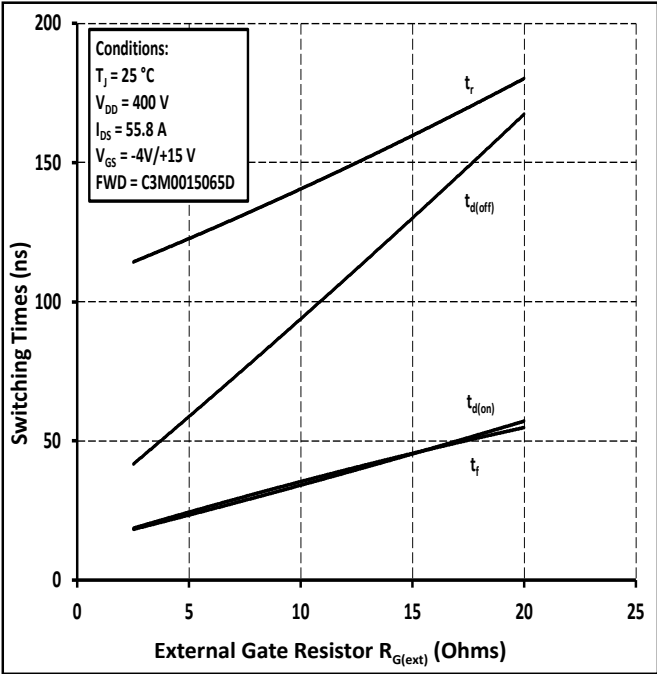


Figure 26. Switching Times vs $R_{G(ext)}$

Test Circuit Schematic

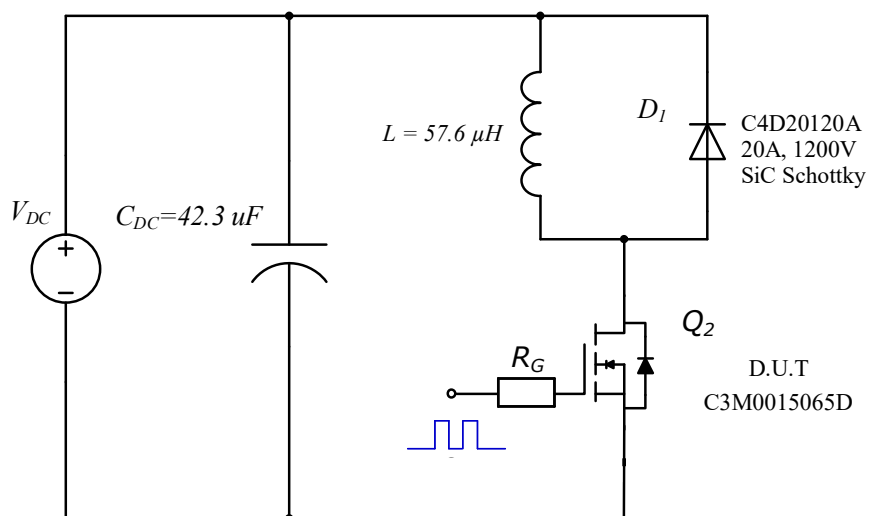


Figure 27. Clamped Inductive Switching Waveform Test Circuit

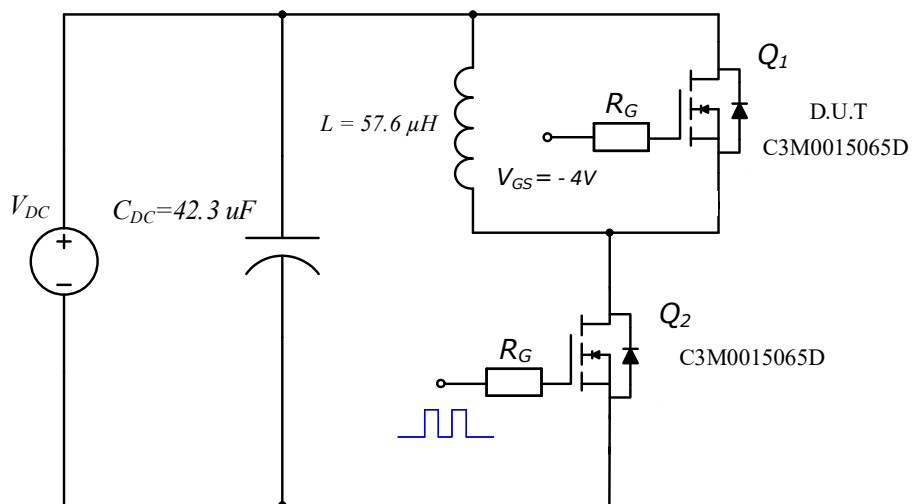
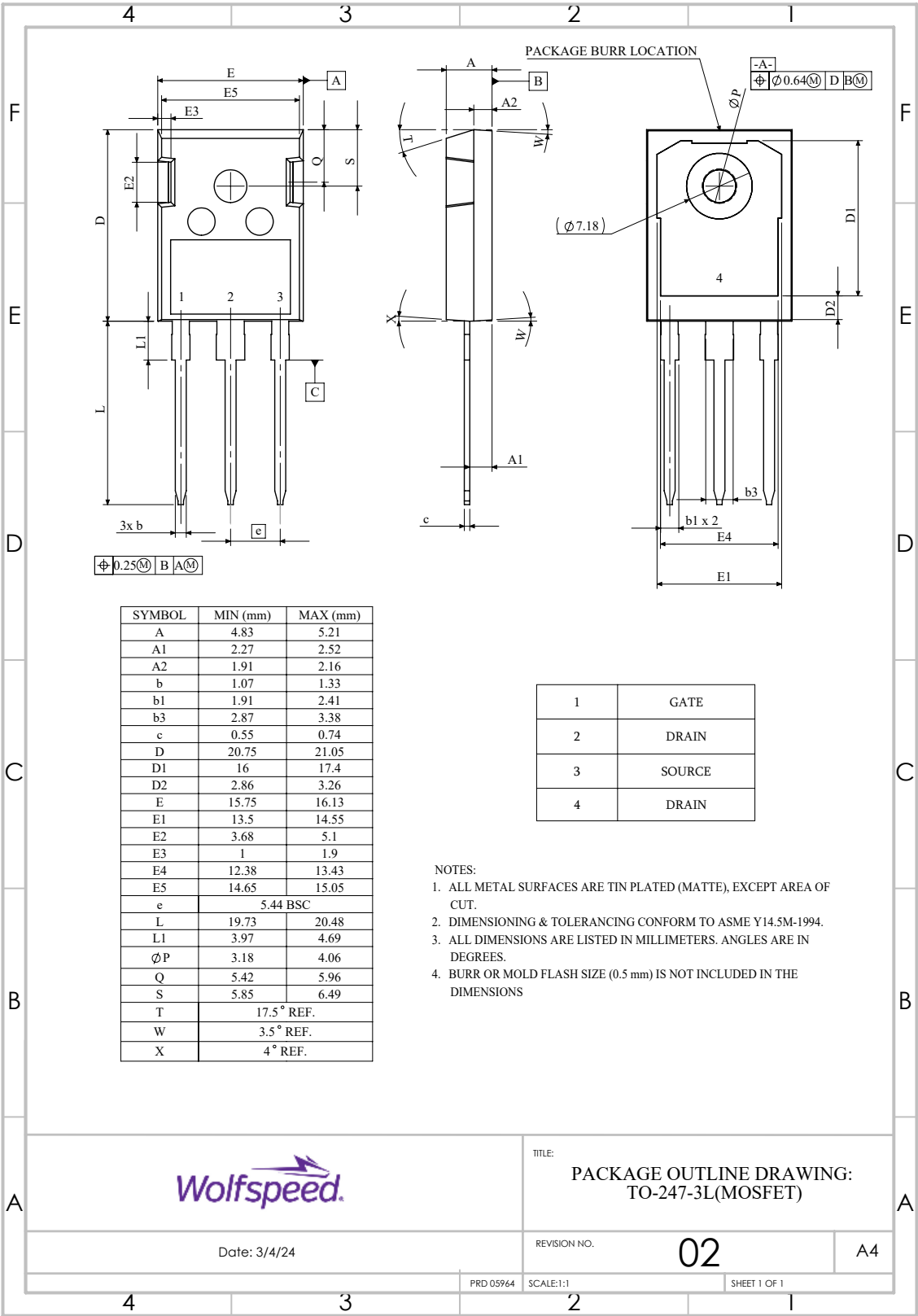


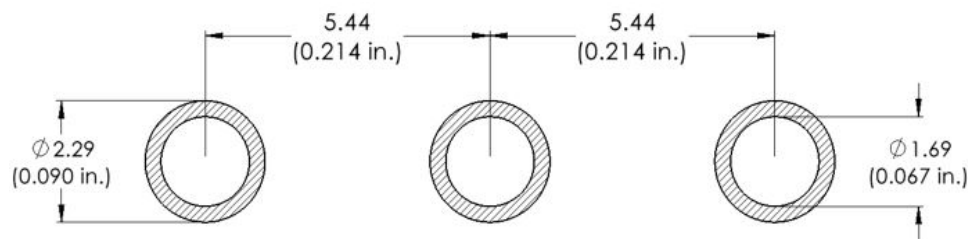
Figure 28. Body Diode Recovery Test Circuit

Package Dimensions

Package: TO-247-3



Recommended Solder Pad Layout



Part Number	Package	Marking
C3M0015065D	TO-247-3	C3M0015065D



Revision History

Current Revision	Date of Release	Description of Changes
7	March-2022	N/A
8	November-2023	Updated Wolfspeed branding, package drawing, package image, and solder pad layout, Table 1 layout revised
9	September - 2024	Legal Disclaimer, POD, Diode Pulse Current Symbol



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